

NP0A456

Silicon PNP epitaxial planar transistor

For High speed switching

■ Features

- Suitable for high-density mounting and downsizing of the equipment
- Automatic insertion with the taping is possible

■ Basic Part Number of Element

- 2SA2082 × 2 elements

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

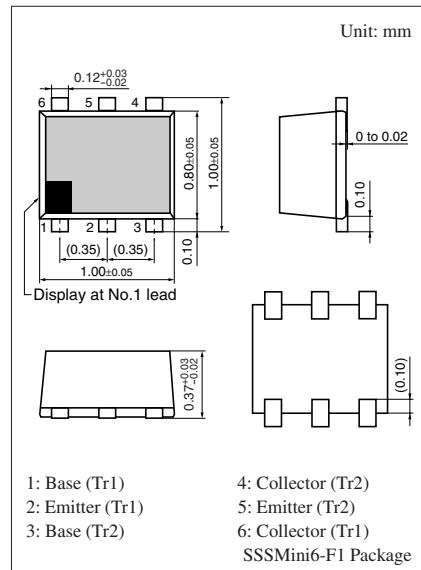
	Parameter	Symbol	Rating	Unit
Rating of element	Collector-base voltage (Emitter open)	V_{CBO}	-15	V
	Collector-emitter voltage (Base open)	V_{CEO}	-15	V
	Emitter-base voltage (Collector open)	V_{EBO}	-4	V
	Collector current	I_C	-50	mA
	Peak collector current	I_{CP}	-100	mA
Overall	Total power dissipation *	P_T	125	mW
	Junction temperature	T_j	125	°C
	Storage temperature	T_{stg}	-55 to +125	°C

Note) *: Measuring on substrate at 17 mm × 10 mm × 1 mm

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

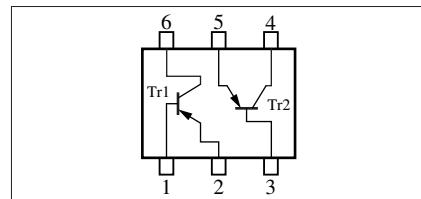
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -8 \text{ V}$, $I_E = 0$			-0.1	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = -3 \text{ V}$, $I_C = 0$			-0.1	μA
Forward current transfer ratio	h_{FE1}	$V_{CE} = -1 \text{ V}$, $I_C = -10 \text{ mA}$	50		150	—
	h_{FE2}	$V_{CE} = -1 \text{ V}$, $I_C = -1 \text{ mA}$	30			—
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C = -10 \text{ mA}$, $I_B = -1 \text{ mA}$		-0.1	-0.2	V
Transition frequency	f_T	$V_{CB} = -10 \text{ V}$, $I_E = 10 \text{ mA}$, $f = 200 \text{ MHz}$	800	1 500		MHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = -5 \text{ V}$, $I_E = 0$, $f = 1 \text{ MHz}$		1		pF
Turn-on time	t_{on}	Refer to the switching time measurement circuit		12		ns
Turn-off time	t_{off}			20		ns
Storage time	f_{stg}			19		ns

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

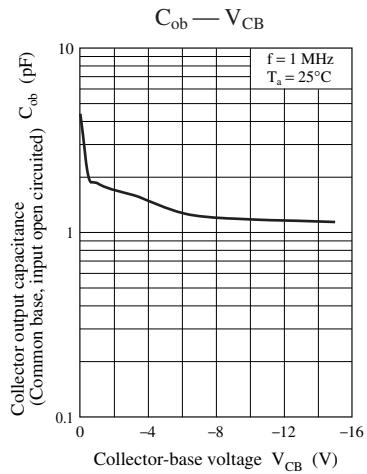
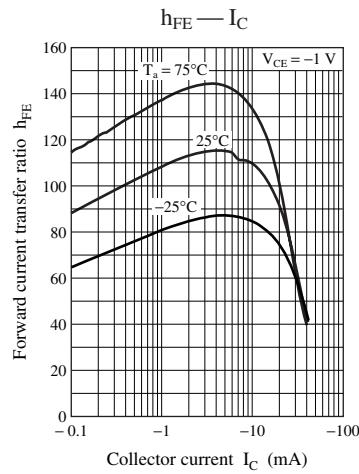
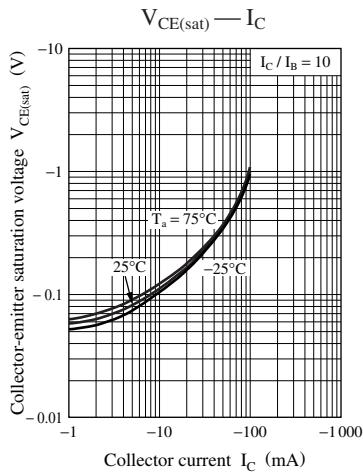
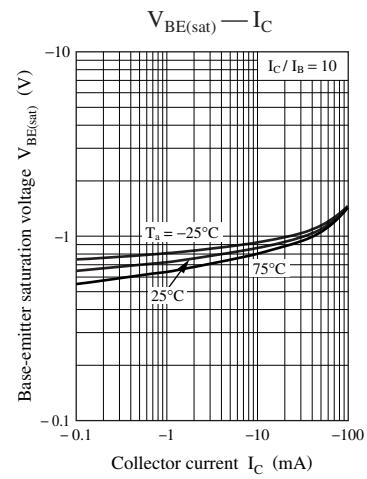
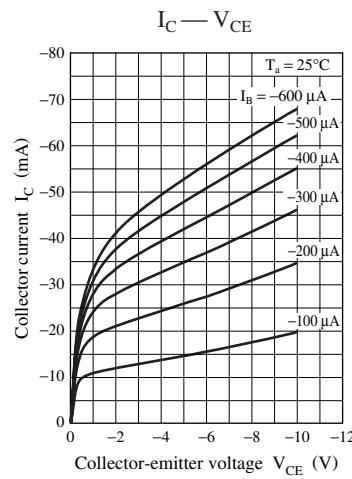
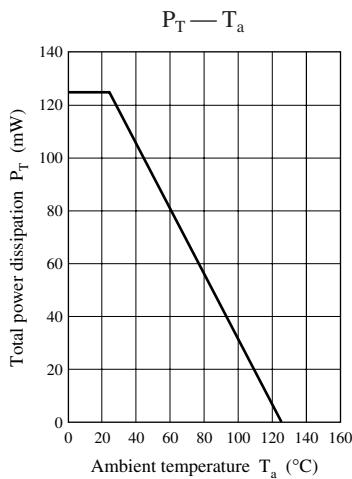
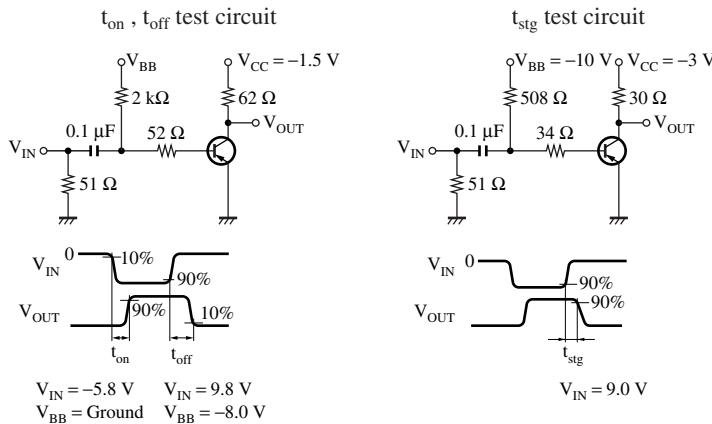


Marking Symbol: 3E

Internal Connection



Switching time measurement circuit



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